

09-19-2001

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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy the

1 Name of conveying party(ies):

Wong-Cheng Shih
Tai Bor Wu
Chich-Shang Chang

09/06/01

2 Name and address of receiving party(ies):

Taiwan Semiconductor Manufacturing Co. Ltd.
No. 121 Park Avenue 3
Science-Based Industrial Park
Hsin-Chu, Taiwan, R.O.C.

3 Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other:

Execution Date: July 18, 2001

Additional name(s) & address(es) attached ☐ Yes ☒ No

4 Application number(s) or patent number(s):

09/947786

If this document is being filed together with a new application, the execution date of the application is: 07-18-01

A. Patent Application No(s).

B. Patent No(s)

Additional numbers attached? ☐ Yes ☒ No

5 Name and address of party to whom correspondence concerning document should be mailed:

RANDY W. TUNG
Tung & Associates
838 W. Long Lake Road
Suite 120
Bloomfield Hills, Michigan 48302

6 Total number of applications and patents involved:

1

7 Total fee (37 CFR 3.41)

\$40.00

☐ Enclosed☒ Authorized to charge credit card (w/filing fee)

8 Deposit Account Number:

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9 Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Randy W. Tung
Name of Person Signing
Registration No. 31,311

Signature
Sept. 6, 2001
Date

Total number of pages including cover sheet, attachments, and document: 3

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

67,200-482

PATENT
REEL: 012163 FRAME: 0081

ASSIGNMENT


WHEREAS, we, WONG-CHENG SHIH, TAI BOR WU and CHICH SHANG CHANG have invented certain improvements in MICROELECTRONIC CAPACITOR WITH BARRIER LAYER for which we are about to make application for Letters Patent of the United States; and

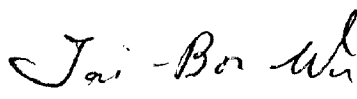
WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, WONG-CHENG SHIH, TAI BOR WU and CHICH SHANG CHANG, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the 18 day of July, 2001, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional,

continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.


WONG CHENG SHIH


TAI BOR WU


CHICH SHANG CHANG

TUNG & ASSOCIATES
838 W. Long Lake Road
Suite 120
Bloomfield Hills, Michigan 48302